

# MB2541 <br> Dual octal buffer line driver (3-State) 

## 16-bit buffer/line drivers (3-State)

MB2541

## FEATURES

- Two 8-bit bus interfaces
- Power-up 3-State
- Multiple $\mathrm{V}_{\mathrm{CC}}$ and GND pins minimize switching noise
- Provides ideal interface and increases fan-out of MOS Microprocessors
- 3-State buffers sink 64 mA and source 32 mA
- Latch-up protection exceeds 500mA per Jedec Std 17
- ESD protection exceeds 2000 V per MIL STD 883 Method 3015 and 200 V per Machine Model
- Inputs are disabled during 3-State mode


## DESCRIPTION

The MB2541 high-performance BiCMOS device combines low static and dynamic power dissipation with high speed and high output drive.

The MB2541 has two 8-bit buffers that are ideal for driving bus lines. The outputs are all capable of sinking 64 mA and sourcing 32 mA .

## QUICK REFERENCE DATA

| SYMBOL | PARAMETER | CONDITIONS $\mathrm{T}_{\mathrm{amb}}=25^{\circ} \mathrm{C} ; \mathrm{GND}=0 \mathrm{~V}$ | TYPICAL | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { tpLH } \\ & \text { tpH } \end{aligned}$ | Propagation delay nlx to nYx | $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF} ; \mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$ | $\begin{aligned} & 3.0 \\ & 3.1 \end{aligned}$ | ns |
| $\mathrm{C}_{\text {IN }}$ | Input capacitance | $\mathrm{V}_{1}=0 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{CC}}$ | 4 | pF |
| Cout | Output capacitance | $\mathrm{V}_{\mathrm{O}}=0 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{CC}} ; 3$-State | 7 | pF |
| ICCz | Total supply current | Outputs disabled; $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$ | 65 | $\mu \mathrm{A}$ |

## ORDERING INFORMATION

| PACKAGES | TEMPERATURE RANGE | OUTSIDE NORTH AMERICA | NORTH AMERICA | DWG NUMBER |
| :---: | :---: | :---: | :---: | :---: |
| $52-$ pin plastic Quad Flat Pack | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | MB2541 BB | MB2541 BB | SOT379-1 |

## PIN CONFIGURATION



PIN DESCRIPTION

| PIN NUMBER | SYMBOL | NAME AND FUNCTION |
| :---: | :---: | :---: |
| $\begin{aligned} & 44,43,41,40, \\ & 38,37,35,34, \\ & 32,31,29,28, \\ & 26,25,23,22 \end{aligned}$ | $\begin{aligned} & 1 \mathrm{AO}-1 \mathrm{~A} 7 \\ & 2 \mathrm{AO}-2 \mathrm{~A} 7 \end{aligned}$ | Data inputs |
| $\begin{gathered} 48,49,51,52, \\ 2,3,5,6, \\ 8,9,11,12, \\ 14,15,17,18 \end{gathered}$ | $\begin{aligned} & 1 \mathrm{YO}-1 \mathrm{Y7}, \\ & 2 \mathrm{YO}-2 \mathrm{Y} \end{aligned}$ | Data outputs |
| 47, 45, 19, 21 | $\begin{aligned} & 1 \mathrm{OE} 0,1 \mathrm{OE} 1, \\ & 2 \mathrm{OE} 0,2 \mathrm{OE} 1 \end{aligned}$ | Output enables |
| $\begin{gathered} 4,7,10,16, \\ 20,24,30,33, \\ 36,42,46,50 \end{gathered}$ | GND | Ground (0V) |
| 1, 13, 27, 39 | $\mathrm{V}_{\mathrm{Cc}}$ | Positive supply voltage |

## LOGIC SYMBOL



## LOGIC SYMBOL (IEEE/IEC)



## FUNCTION TABLE

| INPUTS |  |  | OUTPUTS |
| :---: | :---: | :---: | :---: |
| nOE0 | nOE1 | nlx | nYx |
| $L$ | $L$ | $L$ | $L$ |
| $L$ | $L$ | $H$ | $H$ |
| $X$ | $H$ | $X$ | $Z$ |
| $H$ | $X$ | $X$ | $Z$ |

ABSOLUTE MAXIMUM RATINGS ${ }^{1,2}$

| SYMBOL | PARAMETER | CONDITIONS | RATING | UNIT |
| :---: | :--- | :---: | :---: | :---: |
| $\mathrm{V}_{\text {CC }}$ | DC supply voltage | -0.5 to +7.0 | V |  |
| $\mathrm{I}_{\text {IK }}$ | DC input diode current | $\mathrm{V}_{\mathrm{I}}<0$ | -18 | mA |
| $\mathrm{~V}_{\text {I }}$ | DC input voltage ${ }^{3}$ |  | -1.2 to +7.0 | V |
| $\mathrm{I}_{\text {OK }}$ | DC output diode current | $\mathrm{V}_{\mathrm{O}}<0$ | -50 | mA |
| $\mathrm{~V}_{\text {OUT }}$ | DC output voltage ${ }^{3}$ | output in Off or High state | -0.5 to +5.5 | V |
| l OUT | DC output current | output in Low state | 128 | mA |
| $\mathrm{~T}_{\text {stg }}$ | Storage temperature range |  | -65 to 150 | ${ }^{\circ} \mathrm{C}$ |

## NOTES:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
2. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed $150^{\circ} \mathrm{C}$.
3. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

## RECOMMENDED OPERATING CONDITIONS

| SYMBOL | PARAMETER | LIMITS |  | UNIT |
| :---: | :--- | :---: | :---: | :---: |
|  |  | Min | Max |  |
| $\mathrm{V}_{\mathrm{CC}}$ | DC supply voltage | 4.5 | 5.5 | V |
| $\mathrm{~V}_{\mathrm{I}}$ | Input voltage | 0 | $\mathrm{~V}_{\mathrm{CC}}$ | V |
| $\mathrm{V}_{\mathrm{IH}}$ | High-level input voltage | 2.0 |  | V |
| $\mathrm{~V}_{\mathrm{IL}}$ | Low-level Input voltage |  | 0.8 | V |
| $\mathrm{I}_{\mathrm{OH}}$ | High-level output current |  | -32 | mA |
| $\mathrm{I}_{\mathrm{OL}}$ | Low-level output current |  | 64 | mA |
| $\Delta \mathrm{t} / \Delta \mathrm{V}$ | Input transition rise or fall rate | 0 | 10 | $\mathrm{~ns} / \mathrm{V}$ |
| $\mathrm{T}_{\text {amb }}$ | Operating free-air temperature range | -40 | +85 | ${ }^{\circ} \mathrm{C}$ |

## DC ELECTRICAL CHARACTERISTICS

| SYMBOL | PARAMETER | TEST CONDITIONS | LIMITS |  |  |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\mathrm{T}_{\text {amb }}=+25^{\circ} \mathrm{C}$ |  |  | $\begin{gathered} \mathrm{T}_{\mathrm{amb}}=-40^{\circ} \mathrm{C} \\ \text { to }+85^{\circ} \mathrm{C} \end{gathered}$ |  |  |
|  |  |  | Min | Typ | Max | Min | Max |  |
| $\mathrm{V}_{\mathrm{IK}}$ | Input clamp voltage | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V} ; \mathrm{I}_{\mathrm{IK}}=-18 \mathrm{~mA}$ |  | -0.9 | -1.2 |  | -1.2 | V |
| $\mathrm{V}_{\mathrm{OH}}$ | High-level output voltage | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V} ; \mathrm{I}_{\mathrm{OH}}=-3 \mathrm{~mA} ; \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IL}}$ or $\mathrm{V}_{\mathrm{IH}}$ | 2.5 | 2.9 |  | 2.5 |  | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V} ; \mathrm{I}_{\mathrm{OH}}=-3 \mathrm{~mA} ; \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IL}}$ or $\mathrm{V}_{\mathrm{IH}}$ | 3.0 | 3.4 |  | 3.0 |  | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V} ; \mathrm{I}_{\mathrm{OH}}=-32 \mathrm{~mA} ; \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IL}}$ or $\mathrm{V}_{\mathrm{IH}}$ | 2.0 | 2.4 |  | 2.0 |  | V |
| $\mathrm{V}_{\text {OL }}$ | Low-level output voltage | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V} ; \mathrm{l}_{\mathrm{OL}}=64 \mathrm{~mA} ; \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IL}}$ or $\mathrm{V}_{\mathrm{IH}}$ |  | 0.42 | 0.55 |  | 0.55 | V |
| 1 | Input leakage current | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V} ; \mathrm{V}_{1}=\mathrm{GND}$ or 5.5 V |  | $\pm 0.01$ | $\pm 1.0$ |  | $\pm 1.0$ | $\mu \mathrm{A}$ |
| IOFF | Power-off leakage current | $\mathrm{V}_{\mathrm{CC}}=0.0 \mathrm{~V} ; \mathrm{V}_{\mathrm{O}}$ or $\mathrm{V}_{1} \leq 4.5 \mathrm{~V}$ |  | $\pm 5.0$ | $\pm 100$ |  | $\pm 100$ | $\mu \mathrm{A}$ |
| IPU/ ${ }_{\text {PD }}$ | Power-up/down 3-State output current | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=2.0 \mathrm{~V} ; \mathrm{V}_{\mathrm{O}}=0.5 \mathrm{~V} ; \mathrm{V}_{\mathrm{I}}=\mathrm{GND} \text { or } \mathrm{V}_{\mathrm{CC}} ; \\ & \mathrm{V}_{\mathrm{OE}}=\mathrm{V}_{\mathrm{CC}} \end{aligned}$ |  | $\pm 5.0$ | $\pm 50$ |  | $\pm 50$ | $\mu \mathrm{A}$ |
| $\mathrm{l}_{\text {OzH }}$ | 3-State output High current | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V} ; \mathrm{V}_{\mathrm{O}}=2.7 \mathrm{~V} ; \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IL}}$ or $\mathrm{V}_{\mathrm{IH}}$ |  | 5.0 | 50 |  | 50 | $\mu \mathrm{A}$ |
| lozl | 3-State output Low current | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V} ; \mathrm{V}_{\mathrm{O}}=0.5 \mathrm{~V} ; \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IL}}$ or $\mathrm{V}_{\mathrm{IH}}$ |  | -5.0 | -50 |  | -50 | $\mu \mathrm{A}$ |
| $I_{\text {CEX }}$ | Output high leakage current | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V} ; \mathrm{V}_{\mathrm{O}}=5.5 \mathrm{~V} ; \mathrm{V}_{\mathrm{I}}=\mathrm{GND}$ or $\mathrm{V}_{\mathrm{CC}}$ |  | 5.0 | 50 |  | 50 | $\mu \mathrm{A}$ |
| lo | Output current ${ }^{1}$ | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V} ; \mathrm{V}_{\mathrm{O}}=2.5 \mathrm{~V}$ | -50 | -70 | -180 | -50 | -180 | mA |
| $\mathrm{I}_{\mathrm{CCH}}$ | Quiescent supply current | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$; Outputs High, $\mathrm{V}_{\mathrm{I}}=$ GND or $\mathrm{V}_{\mathrm{CC}}$ |  | 65 | 250 |  | 250 | $\mu \mathrm{A}$ |
| ICCL |  | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$; Outputs Low, $\mathrm{V}_{\mathrm{I}}=\mathrm{GND}$ or $\mathrm{V}_{\mathrm{CC}}$ |  | 48 | 60 |  | 60 | mA |
| ICCz |  | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$; Outputs 3-State; $\mathrm{V}_{\mathrm{I}}=\mathrm{GND}$ or $\mathrm{V}_{\mathrm{CC}}$ |  | 65 | 250 |  | 250 | $\mu \mathrm{A}$ |
| $\Delta_{\text {l }}$ | Additional supply current per input pin ${ }^{2}$ | Outputs enabled, one input at 3.4 V , other inputs at $\mathrm{V}_{\mathrm{CC}}$ or GND ; $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$ |  | 0.5 | 1.5 |  | 1.5 | mA |

## NOTES:

1. Not more than one output should be tested at a time, and the duration of the test should not exceed one second.
2. This is the increase in supply current for each input at 3.4 V .

## AC CHARACTERISTICS

$\mathrm{GND}=0 \mathrm{~V} ; \mathrm{t}_{\mathrm{R}}=\mathrm{t}_{\mathrm{F}}=2.5 \mathrm{~ns} ; \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=500 \Omega$

| SYMBOL | PARAMETER | WAVEFORM | LIMITS |  |  |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\begin{gathered} \mathrm{T}_{\mathrm{amb}}=+25^{\circ} \mathrm{C} \\ \mathrm{~V}_{\mathrm{cc}}=+5.0 \mathrm{~V} \end{gathered}$ |  |  | $\begin{gathered} \mathrm{T}_{\mathrm{amb}}=-40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \\ \mathrm{~V}_{\mathrm{cc}}=+5.0 \mathrm{~V} \pm 0.5 \mathrm{~V} \end{gathered}$ |  |  |
|  |  |  | Min | Typ | Max | Min | Max |  |
| $\begin{aligned} & \text { tpLH } \\ & \mathrm{t}_{\mathrm{PHL}} \end{aligned}$ | Propagation delay nlx to nYx | 1 | $\begin{aligned} & 1.2 \\ & 1.2 \end{aligned}$ | $\begin{aligned} & 3.0 \\ & 3.1 \end{aligned}$ | $\begin{aligned} & 4.5 \\ & 4.5 \end{aligned}$ | $\begin{aligned} & 1.2 \\ & 1.2 \end{aligned}$ | $\begin{aligned} & 5.1 \\ & 5.1 \end{aligned}$ | ns |
| $\begin{aligned} & \text { tpzH } \\ & \mathrm{t}_{\text {PZL }} \end{aligned}$ | Output enable time to High and Low level | 2 | $\begin{aligned} & 1.3 \\ & 2.1 \end{aligned}$ | $\begin{aligned} & 3.6 \\ & 4.7 \end{aligned}$ | $\begin{aligned} & 5.2 \\ & 6.1 \end{aligned}$ | $\begin{aligned} & 1.3 \\ & 2.1 \end{aligned}$ | $\begin{aligned} & 5.8 \\ & 7.1 \end{aligned}$ | ns |
| $\begin{aligned} & \text { tpHz } \\ & \text { tpLz } \end{aligned}$ | Output disable time from High and Low level | 2 | $\begin{aligned} & 1.8 \\ & 1.7 \end{aligned}$ | $\begin{aligned} & 4.3 \\ & 4.0 \end{aligned}$ | $\begin{aligned} & 6.2 \\ & 5.4 \end{aligned}$ | $\begin{aligned} & 1.8 \\ & 1.7 \end{aligned}$ | $\begin{aligned} & 6.8 \\ & 5.9 \end{aligned}$ | ns |

## AC WAVEFORMS

$\mathrm{V}_{\mathrm{M}}=1.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{IN}}=\mathrm{GND}$ to 3.0 V


Waveform 1. Waveforms Showing the Input (An) to Output (Yn) Propagation Delays


Waveform 2. Waveforms Showing the 3-State Output Enable and Disable Times

## TEST CIRCUIT AND WAVEFORMS






detail X


DIMENSIONS (mm are the original dimensions)

| UNIT | $\mathbf{A}$ <br> max. | $\mathbf{A}_{\mathbf{1}}$ | $\mathbf{A}_{\mathbf{2}}$ | $\mathbf{A}_{\mathbf{3}}$ | $\mathbf{b}_{\mathbf{p}}$ | $\mathbf{c}$ | $\mathbf{D}^{(1)}$ | $\mathbf{E}^{(1)}$ | $\mathbf{e}$ | $\mathbf{H}_{\mathbf{D}}$ | $\mathbf{H}_{\mathbf{E}}$ | $\mathbf{L}$ | $\mathbf{L}_{\mathbf{p}}$ | $\mathbf{v}$ | $\mathbf{w}$ | $\mathbf{y}$ | $\mathbf{Z}_{\mathbf{D}}^{(1)}$ | $\mathbf{Z}_{\mathbf{E}}^{(1)}$ | $\boldsymbol{\theta}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | 2.45 | 0.45 | 2.10 | 0.25 | 0.38 | 0.23 | 10.1 | 10.1 | 0.65 | 13.45 | 13.45 | 1.60 | 0.95 | 0.20 | 0.12 | 0.10 | 1.24 | 1.24 | $7^{0}$ |
| 0.95 | 0.25 | 0.22 | 0.13 | 9.9 | 9.9 | 0.65 | 12.95 | 12.95 | 0.95 | $0^{0}$ |  |  |  |  |  |  |  |  |  |

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

| OUTLINE <br> VERSION | REFERENCES |  |  | EUROPEAN | ISSUE DATE |
| :--- | :---: | :---: | :---: | :---: | :---: |
|  | PROJECTION | EIAJ |  |  |  |
| SOT379-1 |  | JEDEC | MO-108 |  |  |

## NOTES

Data sheet status

| Data sheet <br> status | Product <br> status | Definition [1] |
| :--- | :--- | :--- |
| Objective <br> specification | Development | This data sheet contains the design target or goal specifications for product development. <br> Specification may change in any manner without notice. |
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## Philips Semiconductors

811 East Arques Avenue
P.O. Box 3409

Sunnyvale, California 94088-3409
Telephone 800-234-7381


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